EV-VN5016AJ



Features

Parameter

Operating voltage range

Max On-State resistance

Current limitation (typ)

Off state supply current

for VN5016AJ-E

in prototyping

prototyping

Description

around.

1. Typical value with all loads connected.

Max supply voltage

Symbol

V_{CC}

V_{CC}

 R_{ON}

ILIMH

 I_S

Simple single IC application board dedicated

Provides thermal heat-sinking for ease of use

Provides electrical connectivity for easy

EV-VN5016AJ provides you an easy way to

VN5016AJ-E high-side driver.

connect ST's surface mounted VIPower[®] drivers into your existing prototype circuitry. This evaluation board comes pre-assembled with

The VN5016AJ-E is a monolithic device made using STMicroelectronics[®] VIPower[®] M0-5 technology. It is intended for driving resistive or inductive loads with one side connected to

Active V_{CC} pin voltage clamp protects the device against low energy spikes. This device integrates an analog current sense which delivers a current proportional to the load current (according to a known ratio) when CS_DIS is driven low or left

open. When CS_DIS is driven high, the CURRENT SENSE pin is in a high impedance

Value

41

4.5 to 36

16

65

2

Unit

V

V

mΩ

А

 $\mu A^{(1)}$

VN5016AJ evaluation board

Data brief – production data

Output current limitation protects the device in overload condition. In case of long overload duration, the device limits the dissipated power to safe level up to thermal shutdown intervention. Thermal shutdown with automatic restart allows the device to recover normal operation as soon as fault condition disappears.

Figure 1. VN5016AJ evaluation board

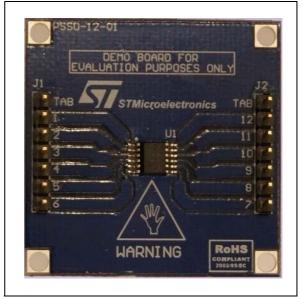


Table 1.Device summary

Order code	Reference
EV-VN5016AJ	VN5016AJ evaluation board

September 2013

condition.

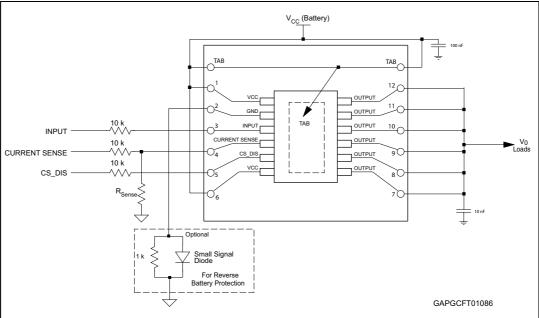
Doc ID 023957 Rev 2

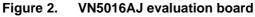
This is information on a product in full production. For further information contact your local STMicroelectronics sales office.

1 Design recommendations

This evaluation board provides mounting solution and some heat sinking capability for prototype development, but there are still external components that are required to make these devices work in any application. For further information on how the evaluation board has to be used you can refer to the AN4210 (see *Appendix A: Reference documents*).

Figure 2 illustrates the necessary components for any application.





ST has produced a user manual for safe designs using ST's VIPower devices. This is UM1556 (see *Appendix A: Reference documents*). UM1556 is a VIPower Hardware design guide that provides all necessary information to successfully design your circuit using our VIPower drivers.

All designs have different needs and requirements. Whatever design you decide to use, it will still need to be verified in order to meet your application specifications. ST implies no guarantee or warranty (see *Appendix A: Reference documents*).



2 Thermal data

Table 2.	VN5016AJ-E	thermal data
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Symbol	Parameter	Max. value	Unit
R _{thj-amb}	Thermal resistance junction-ambient (MAX)	30.5	°C/W

Table 3. PCB specifications

Parameter	Value	Unit
Board dimensions	38 x 38	mm
Number of Cu layer	2	—
Layer Cu thickness	70	μm
Board finish thickness	1.6 +/- 10%	mm
Board Material	FR4	_
Thermal vias separation	1.2	mm
Thermal vias diameter	0.3 /- 0.08	mm



3 Board connector reference



Figure 3. Board layout

Table 4. Board connector specification

Connector	Board lead number	Device pin function ⁽¹⁾
J1	TAB	V _{CC}
J1	1	V _{CC}
J1	2	GND
J1	3	INPUT
J1	4	CURRENT SENSE
J1	5	CS_DIS
J1	6	V _{CC}
J2	TAB	V _{CC}
J2	7	OUTPUT
J2	8	OUTPUT
J2	9	OUTPUT
J2	10	OUTPUT
J2	11	OUTPUT
J2	12	OUTPUT

1. For further clarification on pin functions please refer to the related datasheet (see *Appendix A: Reference documents*).



4 Package information

4.1 ECOPACK[®] packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: <u>www.st.com</u>.

ECOPACK[®] is an ST trademark.



Appendix A Reference documents

- 1. Single channel high side driver with analog current sense for automotive applications (VN5016AJ-E, DocID 10870)
- 2. VIPower M0-5 and M0-5Enhanced high-side drivers (UM1556, DocID 023520)
- 3. PowerSSO-12 devices evaluation bord (AN4210, DocID 023963)
- 4. Evaluation Product Licence Agreement on <u>www.st.com</u>



Revision history

Table 5.	Document	revision	history
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Date	Revision	Changes
28-Nov-2012	1	Initial release.
17-Sep-2013	2	Updated disclaimer.



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